

Features

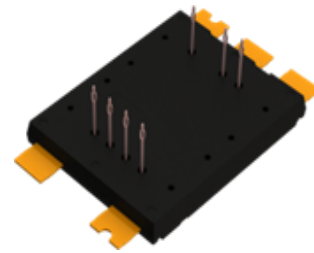
- TRCDRIVE pack™ with the 4th Generation SiC-MOSFET
- $V_{DSS} = 750V$
- Low $R_{DS(on)}$
- High-speed switching possible
- Low switching losses
- Low stray inductance - 5.7nH
- $T_{vjmax} = 175^{\circ}C$
- Compact design
- High power density
- Press-fit contact technology
- Integrated NTC temperature sensor
- Mountable on heatsink with thermal interface material (TIM)
- Weldable power terminals
- Cu clip technology
- Ag sinter technology for die mounting
- Higher power cycling capability
- 4.2kV DC 1s insulation

Construction

The power module is a half bridge module which implements SiC-MOSFETs.

Application

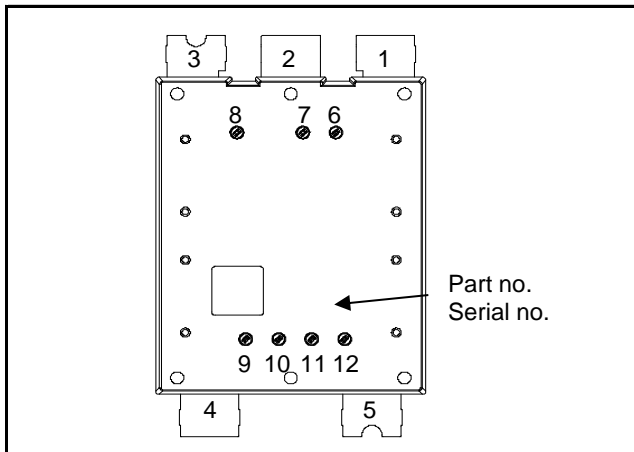
- Automotive application
- Inverter, Converter
- (Hybrid) electrical vehicles EV/HEV



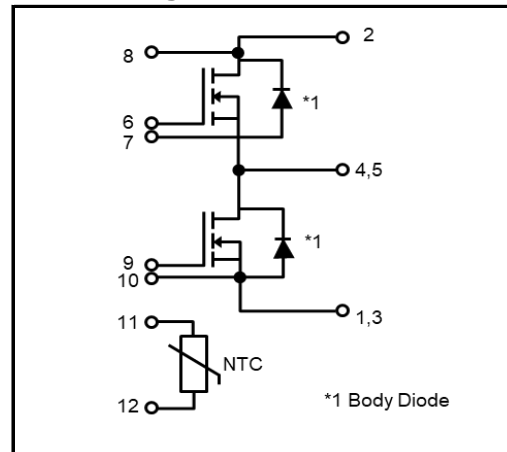
“TRCDRIVE pack™” is a trademark or a registered trademark of ROHM Co., Ltd.

“EcoSiC™” is a trademark or a registered trademark of ROHM Co., Ltd.

Outline



Circuit diagram



Pin No.	Pin Name	Function
1	N	Negative Power
2	P	Positive Power
3	N	Negative Power
4	OUT	Output (S1D2)
5	OUT	Output (S1D2)
6	G1	High side MOSFET Gate
7	Ss1	High side MOSFET Source Sense
8	Ds1	High side MOSFET Drain Sense
9	G2	Low side MOSFET Gate
10	Ss2	Low side MOSFET Source Sense
11	NTC1	NTC
12	NTC2	NTC

Absolute maximum ratings (Tvj = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Rating	Unit
Drain - source voltage	V_{DSS}	$V_{GS} = 0V$	750	V
Gate - source voltage (DC)	V_{GSS}		-4 to +21	
Gate - source voltage ($t_{surge} < 300ns$)	$V_{GSSsurge}$		-6 to +23	
Continuous drain current (DC)	I_D	$Tvj = 175^\circ C, Tc = 60^\circ C, V_{GS} = 18V$	506	A
Pulsed drain current	$I_{D,pulse}$	Pulse 1ms, $Tvj = 175^\circ C, V_{GS} = 18V$ ^{Note 2), 5)}	1012	
Continuous source current (DC)	I_S	$Tvj = 175^\circ C, V_{GS} = 18V$	506	
Pulsed source current	$I_{S,pulse}$	Pulse 1ms, $Tvj = 175^\circ C, V_{GS} = 18V$ ^{Note 2)}	1012	
Body diode surge forward current	$I_{S,pulse}$	Pulse 1.5 μs , $Tvj = 175^\circ C, V_{GS} = 0V$ ^{Note 2), 4), 5)}	1012	
Total power dissipation ^{Note 3), 5)}	P_{tot}	$Tc = 25^\circ C$	1667	W
Virtual junction temperature	Tvj		-40 to +175	
Storage temperature	T_{stg}		-40 to +125	

Note 1) If the product is used beyond absolute maximum ratings defined in the specifications, as its internal structure may be damaged, please replace the product with a new one.

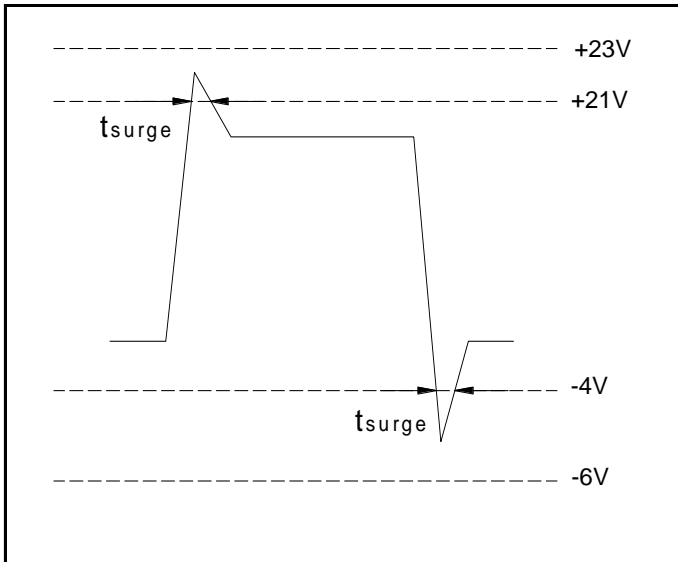
Note 2) Repetition rate should be kept within the range where temperature rise if die should not exceed Tvj_{max} .

Note 3) Case temperature (Tc) is defined on the mounting side surface of copper plate.

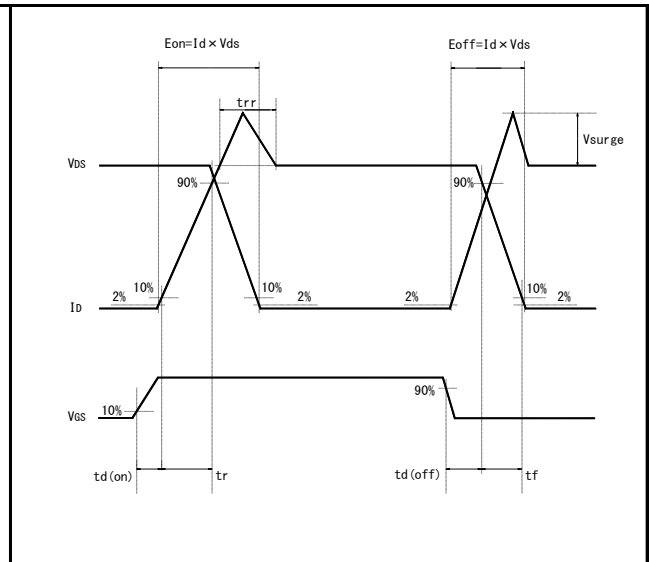
Note 4) Repetitive pulse, $PW \leq 1.5\mu s$, Duty cycle $\leq 5\%$

Note 5) Tvj is less than 175°C.

<Example of acceptable V_{GS} waveform>



<Wavelength for switching test>



Module ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Isolation test voltage	V_{isol}	Terminals to baseplate DC 1s	4200	—	—	V
Stray inductance	L_s		—	5.7	—	nH
Comparative tracking index	CTI		400≤CTI<600			—
Creepage distance	—	Terminal to heat sink	8.0	—	—	mm
		Terminal to terminal	7.4	—	—	
Clearance	—	Terminal to heat sink	6.4	—	—	mm
		Terminal to terminal	5.1	—	—	
Thermal resistance, junction - case	$R_{th(j-c)}$	1/2 module ^{Note 3)}	—	—	90	°C/kW
Module lead resistance, terminals - chip	$R_{DD'+SS'}$		—	0.29	—	mΩ
Weight	G		—	52	—	g

MOSFET electrical characteristics (Tvj = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
			Min.	Typ.	Max.		
Drain - source on resistance	R _{DS(on)}	I _D = 450A, V _{GS} = 18V	Tvj = 25°C	—	2.0	2.5	mΩ
			Tvj = 150°C	—	3.3	—	
			Tvj = 175°C	—	4.0	—	
Zero gate voltage drain current	I _{DSS,leak}	V _{DS} = 750V, V _{GS} = 0V	—	—	320	μA	
Gate - source threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 200mA ^{Note 6)}	2.8	—	4.8	V	
Gate - source leakage current	I _{GSS}	V _{GS} = +21V, V _{DS} = 0V	—	—	0.4	μA	
		V _{GS} = -4V, V _{DS} = 0V	-0.4	—	—		
Turn - on delay time	t _{d(on)}	V _{GS(on)} = 18V, V _{GS(off)} = 0V V _{DS} = 500V I _D = 450A R _{G(on)} = 10Ω, R _{G(off)} = 5.6Ω Inductive load	—	135	—	ns	
Rise time	t _r		—	109	—		
Turn - off delay time	t _{d(off)}		—	387	—		
Fall time	t _f		—	37	—		
Turn - on switching loss	E _{on}		—	28	—		mJ
Turn - off switching loss	E _{off}	—	13	—			
Input capacitance	C _{iss}	V _{DS} = 500V, V _{GS} = 0V, 1MHz	—	30	—	nF	
Total gate charge	Q _g	V _{GS(on)} = 18V, V _{GS(off)} = 0V V _{DS} = 400V I _D = 376A	—	1042	—	nC	
Gate - source charge	Q _{GS}		—	350	—		
Gate - drain charge	Q _{gd}		—	216	—		
Internal gate resistance	R _{Gint}	Tvj = 25°C	—	0.25	—	Ω	

Body diode electrical characteristics (Tvj = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
			Min.	Typ.	Max.		
Souce - drain voltage	V _{F,SD}	V _{GS} = 0V, I _S = 450A	Tvj = 25°C	—	3.7	—	V
			Tvj = 150°C	—	3.6	—	
			Tvj = 175°C	—	3.6	—	
Reverse recovery time	t _{rr}	V _{GS(on)} = 18V, V _{GS(off)} = 0V V _{DS} = 500V I _D = 450A R _{G(on)} = 10Ω, R _{G(off)} = 5.6Ω Inductive load	—	35	—	ns	
Recoverd charge	Q _{rr}		—	1772	—	nC	
Peak reverse recovery current	I _{rr}		—	83	—	A	
Reverse recovery energy	E _{rr}		—	0.1	—	mJ	

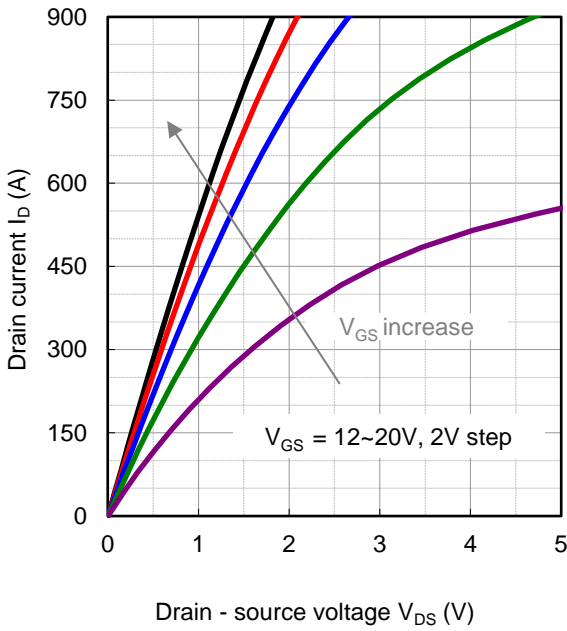
NTC Thermistor electrical characteristics (Tvj = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
NTC rated resistance	R ₂₅	Tc = 25°C	—	4.950	—	kΩ
	R ₉₈	Tc = 98°C	—	0.5185	—	
Deviation of R25	ΔR/R	Tc = 25°C	-5	—	5	%
Power dissipation	P ₂₅	Tc = 25°C	—	—	50	mW
NTC B Value	B _{25/98}	R = R ₂₅ exp [B _{25/98} (1/T - 1/(298.15K))]	—	3420	—	K

- Note 6) Tested after applying $V_{GS} = 21V$ for 100ms.
- Note 7) Not include the resistance from terminals to chip.
- Note 8) SiC devices have lower short circuit withstand capability due to high current density. Please be advised to pay careful attention to short circuit accident and try to adjust protection time to shutdown them as short as possible.

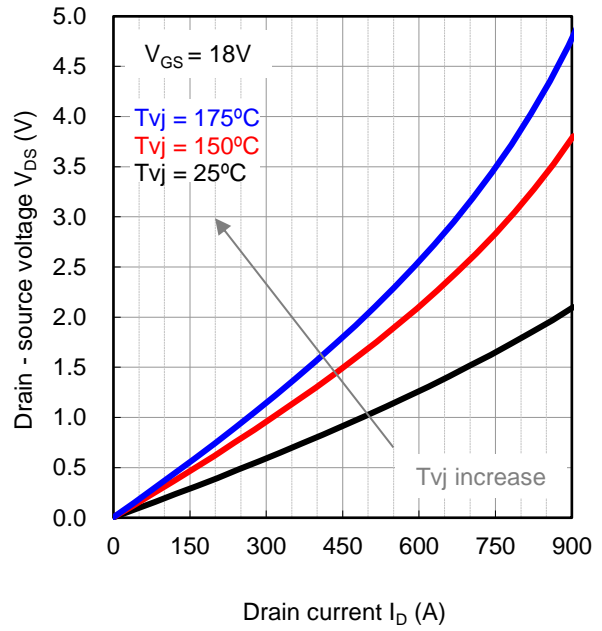
Electrical characteristic curves (Typical)

Figure 1. Output characteristic at 25°C (Typ.)



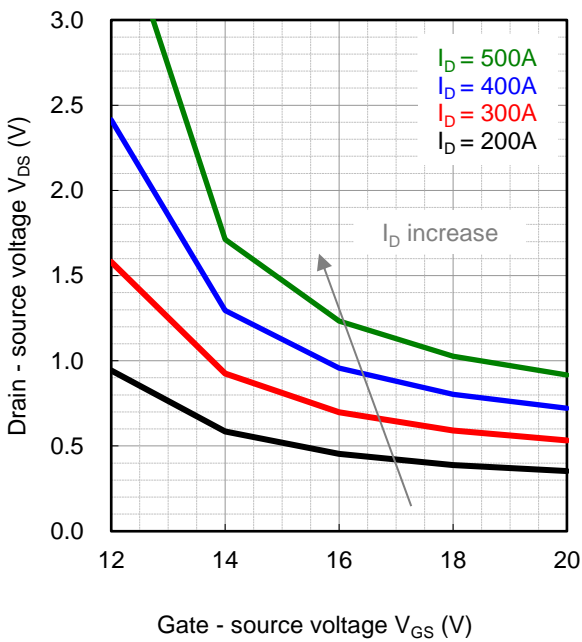
Note 7)

Figure 2. Drain - source voltage characteristic (Typ.)



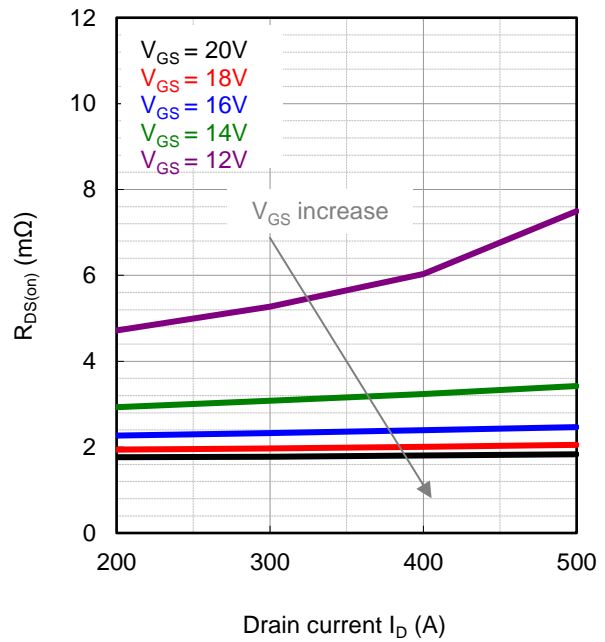
Note 7)

Figure 3. Drain - source voltage characteristic at 25°C (Typ.)



Note 7)

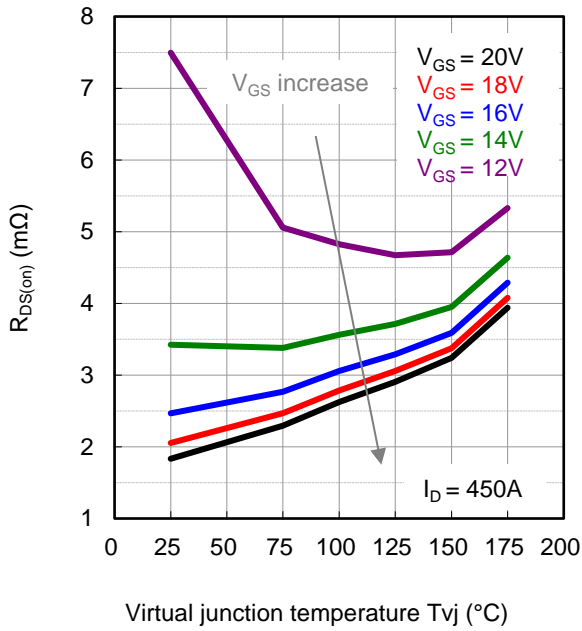
Figure 4. Drain current vs. $R_{DS(on)}$ at 25°C (Typ.)



Note 7)

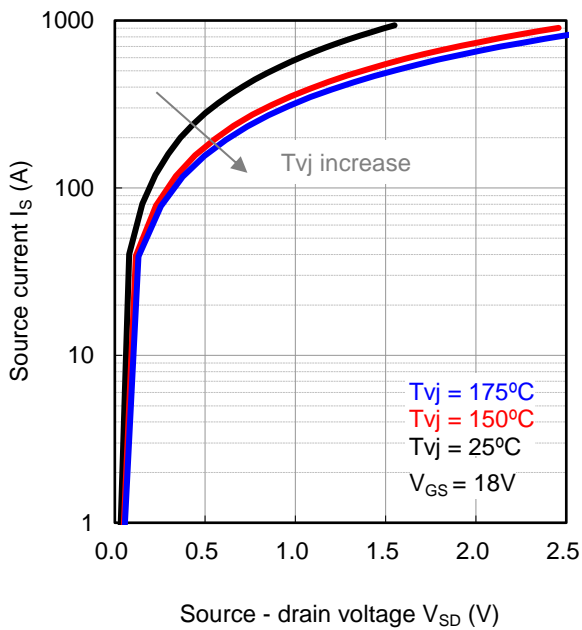
Electrical characteristic curves (Typical)

Figure 5. $R_{DS(on)}$ vs. T_{vj} characteristic (Typ.)



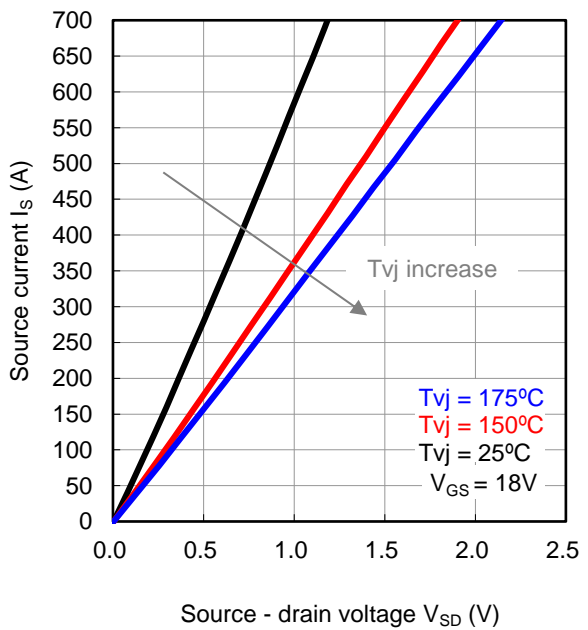
Note 7)

Figure 6. Forward characteristic of diode $V_{GS} = 18V$ (Typ.)



Note 7)

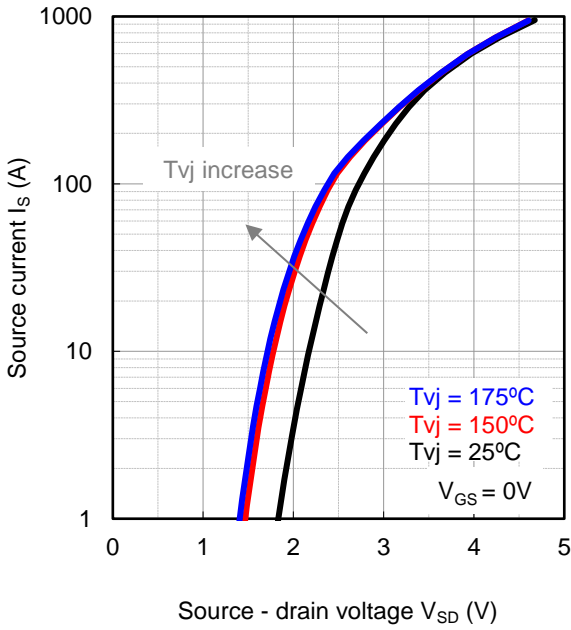
Figure 7. Forward characteristic of diode $V_{GS} = 18V$ (Typ.)



Note 7)

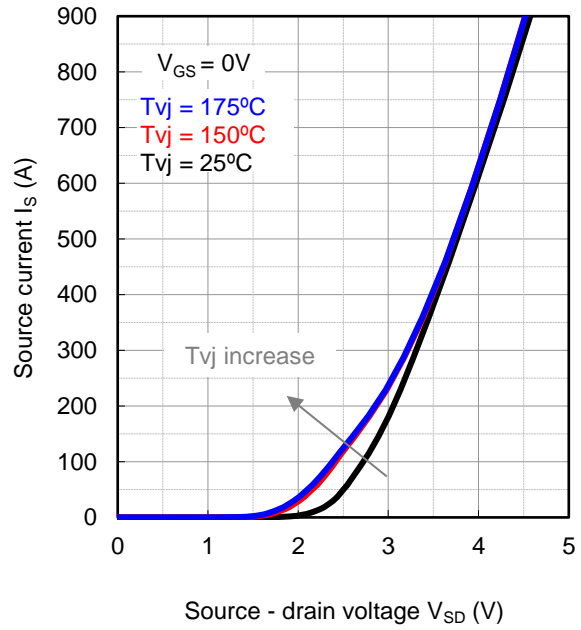
Electrical characteristic curves (Typical)

Figure 8. Forward characteristic of diode
 $V_{GS} = 0V$ (Typ.)



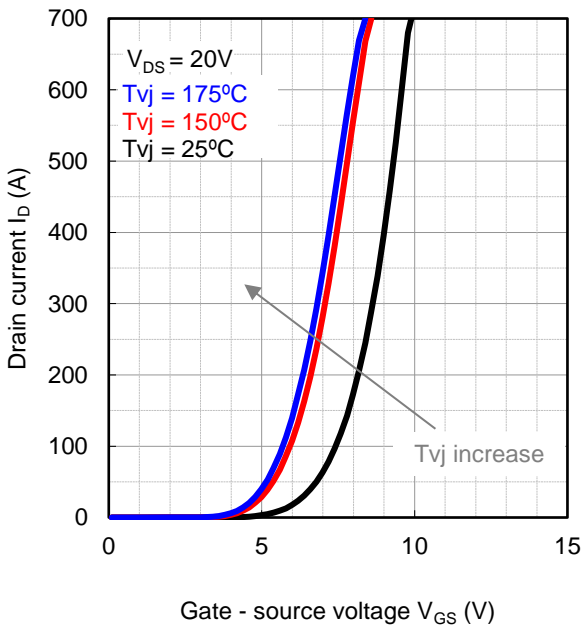
Note 7)

Figure 9. Forward characteristic of diode
 $V_{GS} = 0V$ (Typ.)



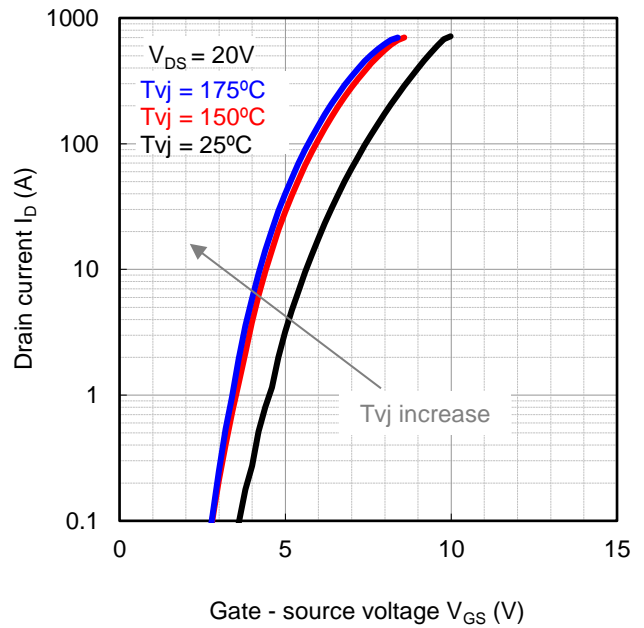
Note 7)

Figure 10. Drain current vs. Gate-source voltage (Typ.)



Note 7)

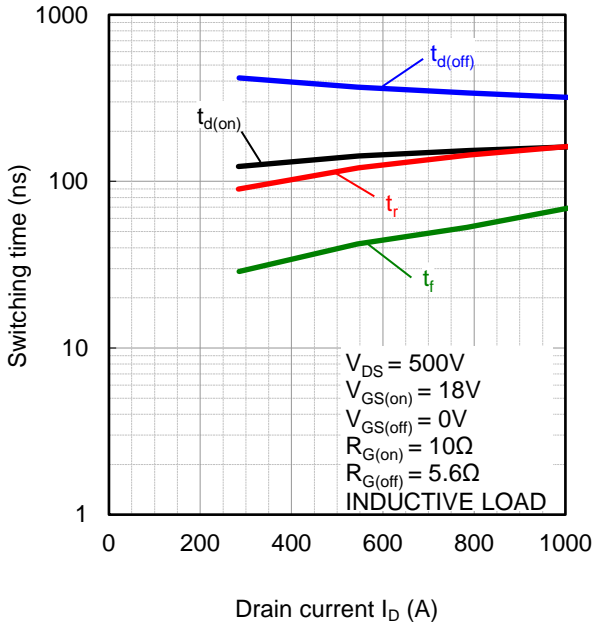
Figure 11. Drain current vs. Gate-source voltage (Typ.)



Note 7)

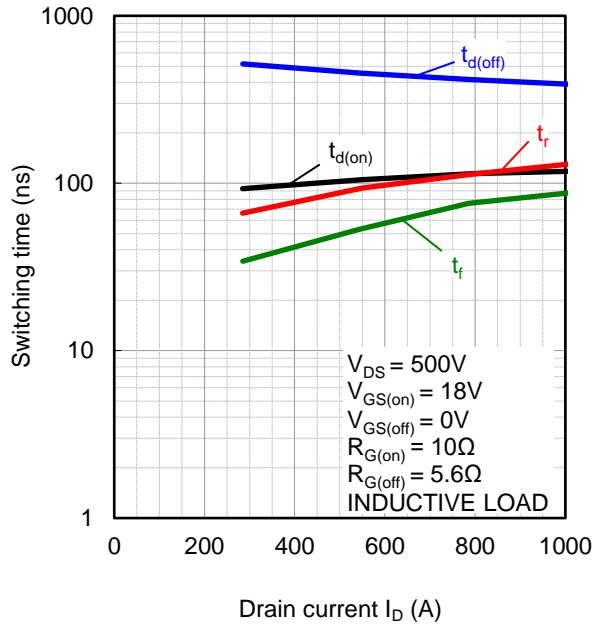
Electrical characteristic curves (Typical)

Figure 12. Switching time vs. Drain current at 25°C (Typ.)



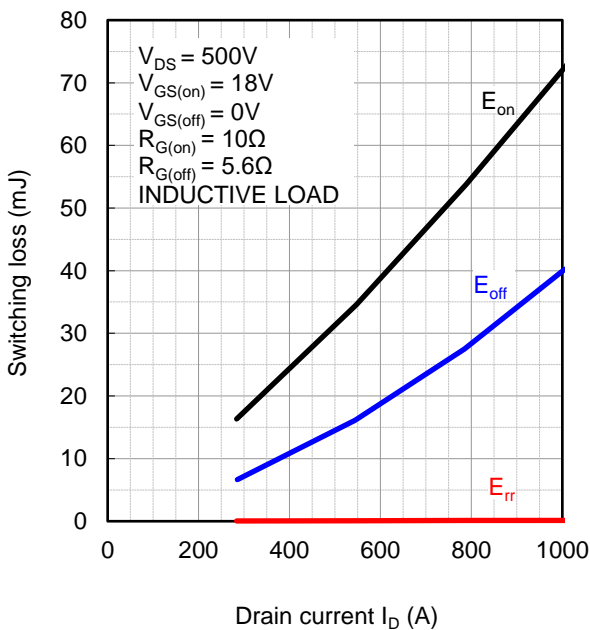
Note 7)

Figure 13. Switching time vs. Drain current at 175°C (Typ.)



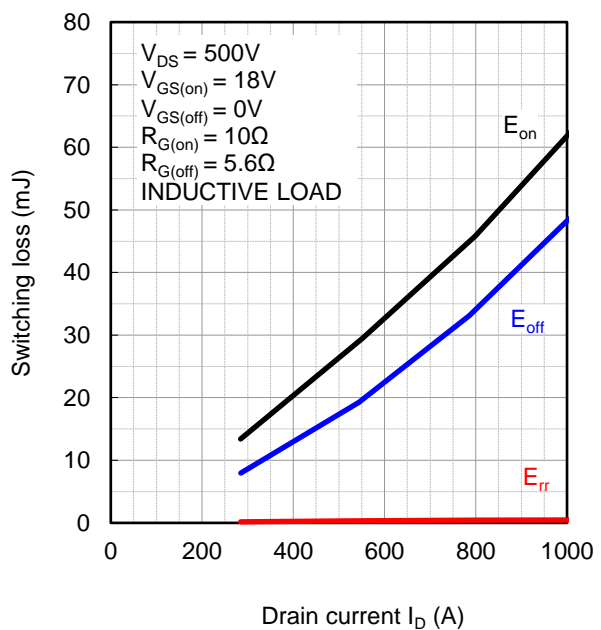
Note 7)

Figure 14. Switching loss vs. Drain current at 25°C (Typ.)



Note 7)

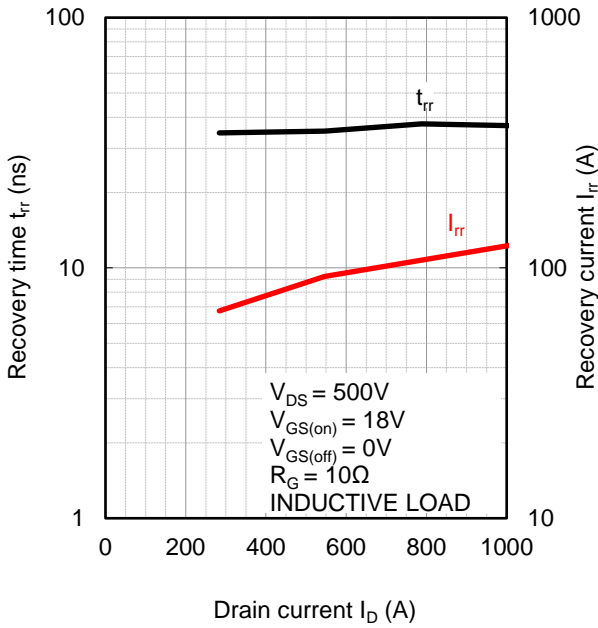
Figure 15. Switching loss vs. Drain current at 175°C (Typ.)



Note 7)

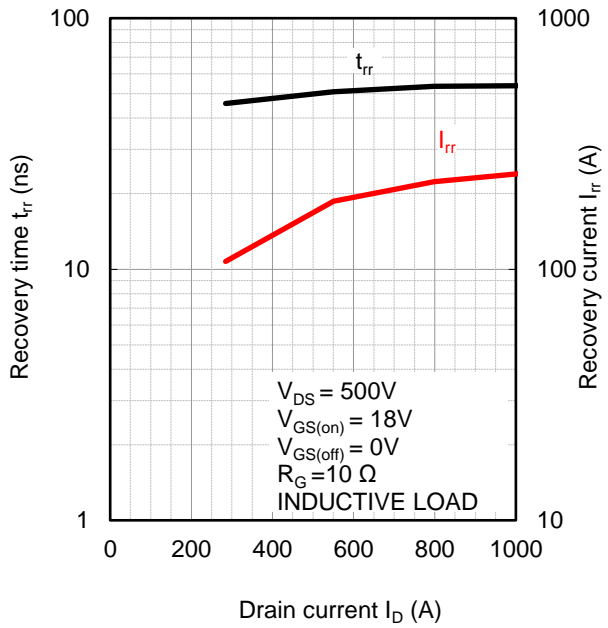
Electrical characteristic curves (Typical)

Figure 16. Recovery characteristic vs. Drain current at 25°C (Typ.)



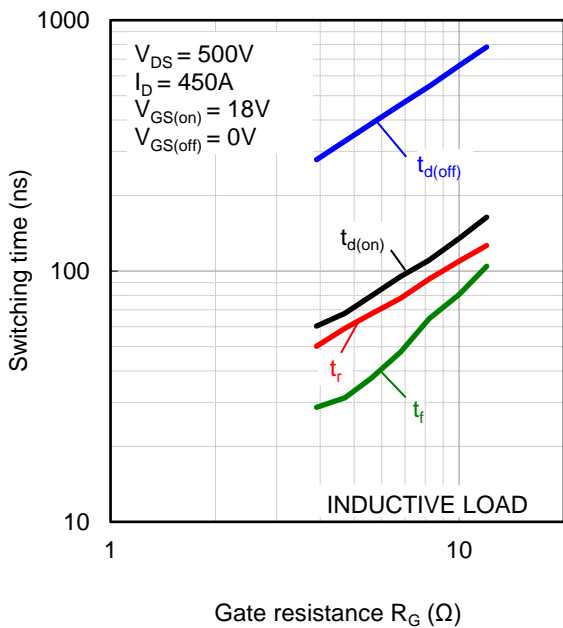
Note 7)

Figure 17. Recovery characteristic vs. Drain current at 175°C (Typ.)



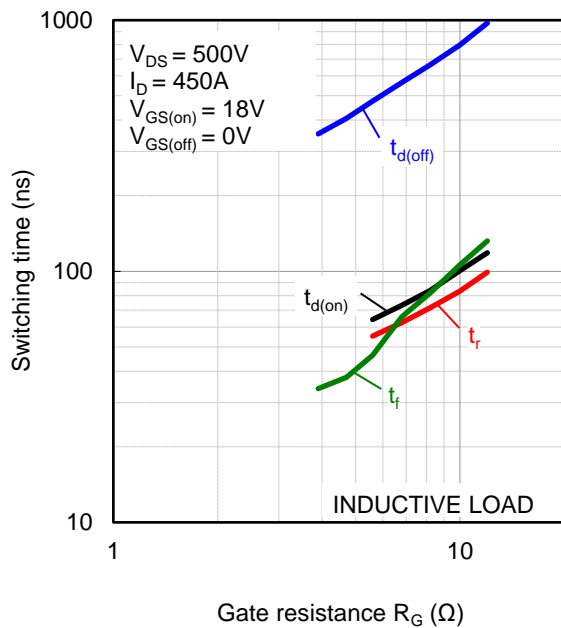
Note 7)

Figure 18. Switching time vs. Gate resistance at 25°C (Typ.)



Note 7)

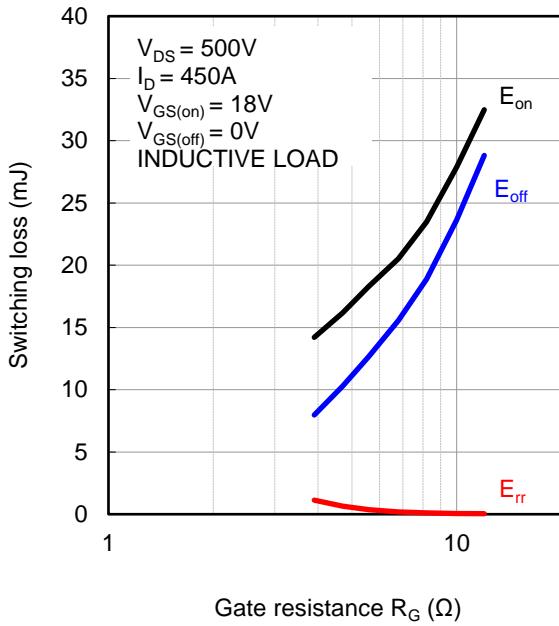
Figure 19. Switching time vs. Gate resistance at 175°C (Typ.)



Note 7)

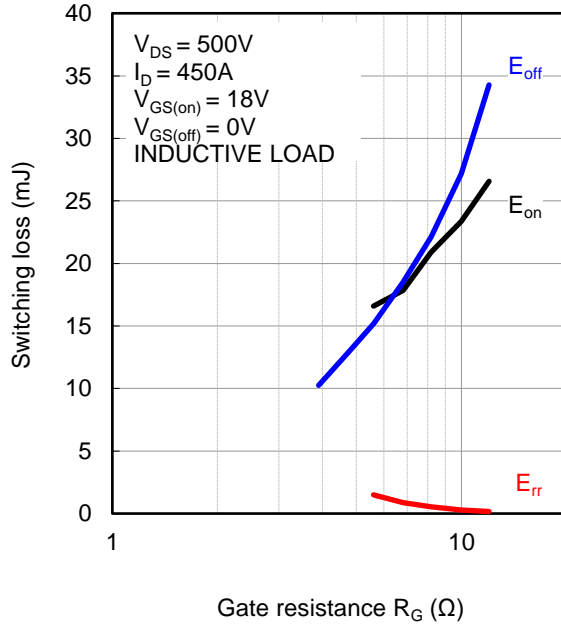
Electrical characteristic curves (Typical)

Figure 20. Switching loss vs. Gate resistance at 25°C (Typ.)



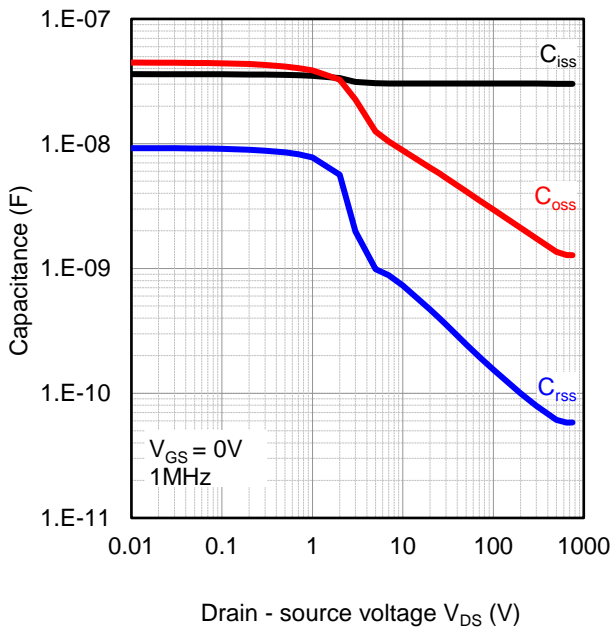
Note 7)

Figure 21. Switching loss vs. Gate resistance at 175°C (Typ.)



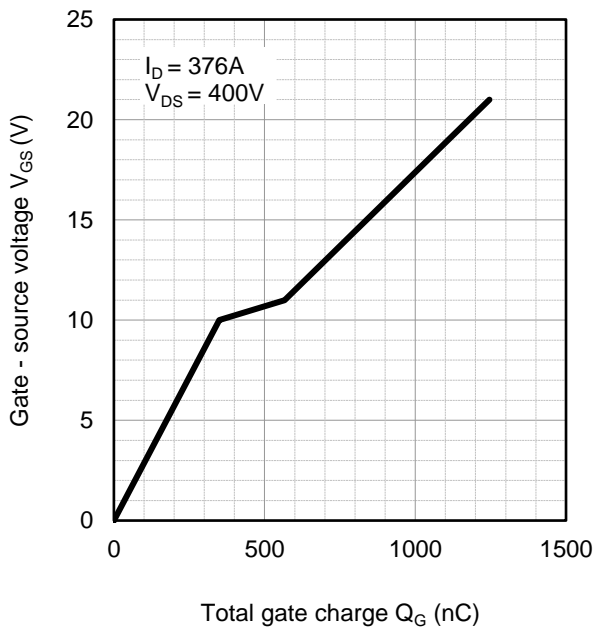
Note 7)

Figure 22. Capacitance vs. Drain - source voltage at 25°C (Typ.)



Note 7)

Figure 23. Gate charge characteristic at 25°C (Typ.)



Note 7)

Electrical characteristic curves (Typical)

Figure 24. Transient thermal impedance (Typ.)

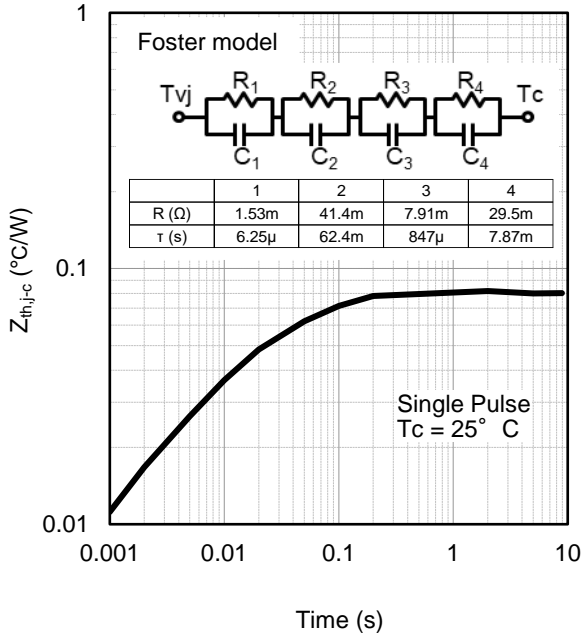


Figure 25. Maximum safe operating area

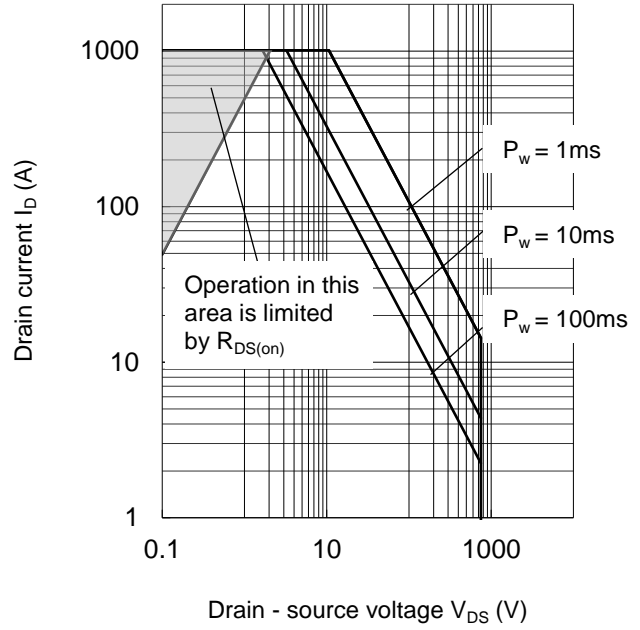


Figure 26. NTC Thermistor temperature characteristic (Typ.)

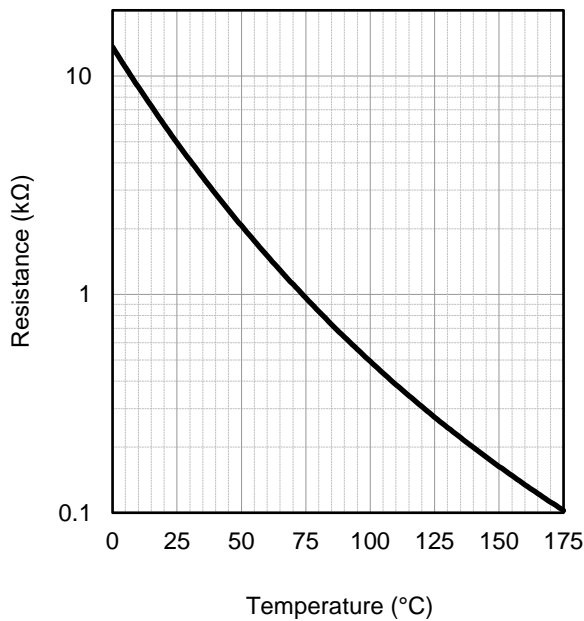
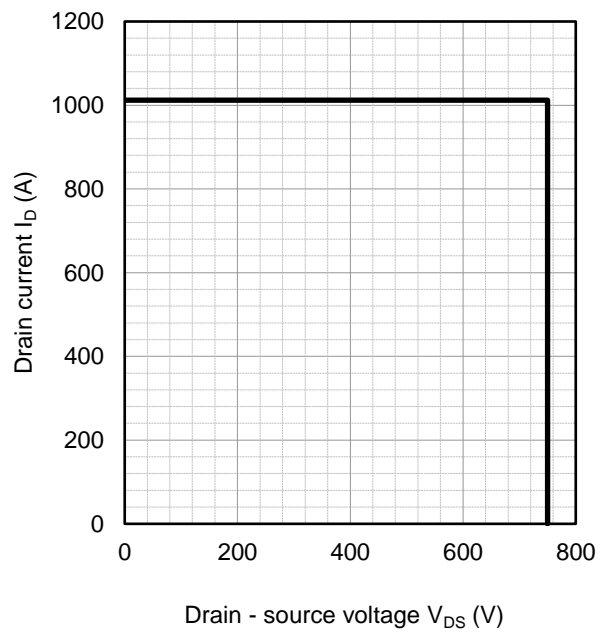
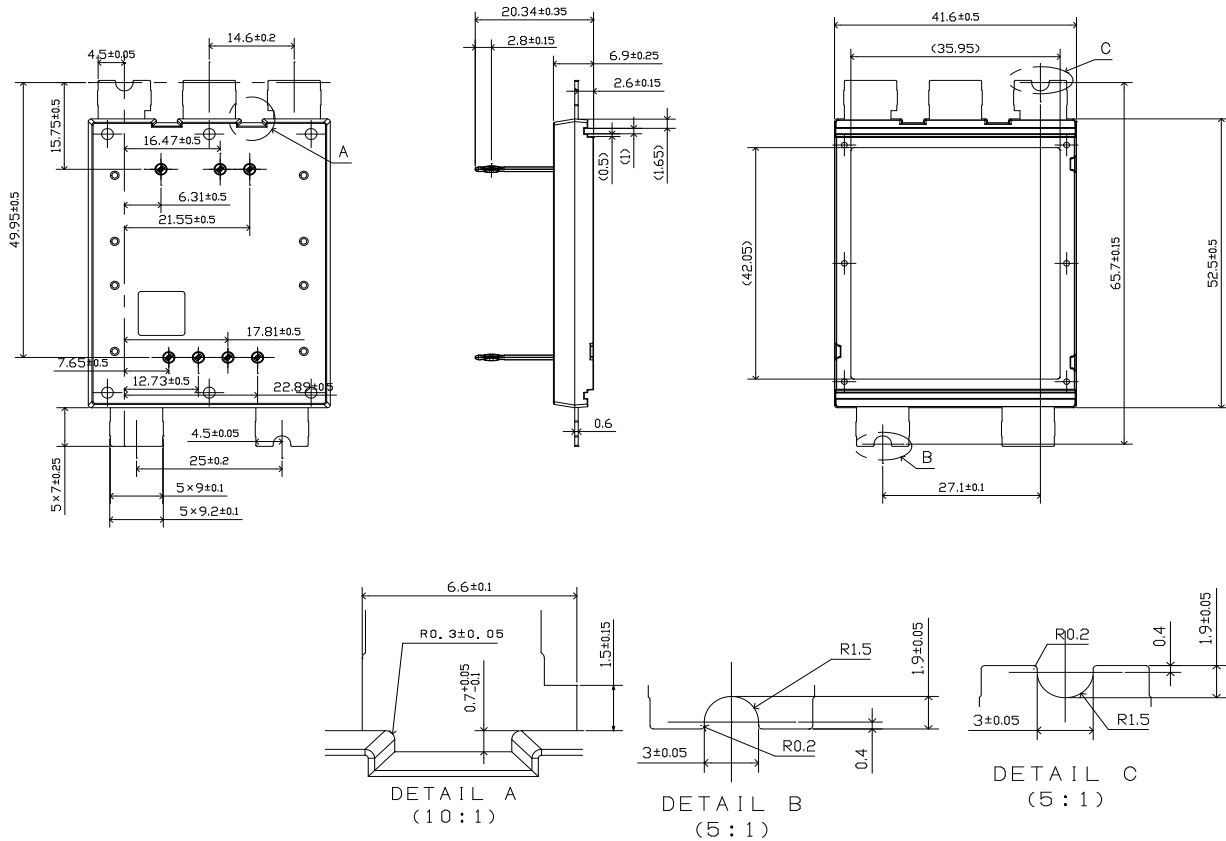


Figure 27. MOSFET RBSOA (Typ.)



Package outlines

Unit : mm



Notes

- 1) The information contained herein is subject to change without notice.
- 2) Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Products beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

<http://www.rohm.com/contact/>

General Precaution

1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.